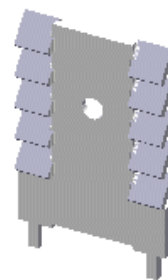


Product- information Type: FI300/Sn

Group: Special heatsinks, Finger shaped heatsinks

Special heatsinks

Application (Cases):	TO220
Number of semiconductors:	1
Mounting of semiconductors :	to screw
Mounting of heatsinks:	to solder
Finish:	tin-plated
Thermal resistance:	29.5 K/W
Material:	Aluminium



heatsink for semiconductor case

